

4-30-01

RE

05-11-2001

ET



To the Honorable Commissioner for Patent:

ent(s) or copy(ies) thereof.

1. Name of Conveying Party(ies):

RANDY L. YACH;

IGOR WOJEWODA

Additional name(s) of conveying party(ies) attached? _____

Yes

X No

2. Name and Address of Party(ies) receiving an interest (assignee(s)):

Name: MICROCHIP TECHNOLOGY INCORPORATED

Address: 2355 WEST CHANDLER BLVD.

CHANDLER, AZ 85224-6199

Country: USA

480.792.7200

Additional name(s) and address(es) attached? _____

Yes

X No

3. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date(s) of the application is: APRIL 30, 2001

A. Patent Application No(s):

B. Patent No(s):

This application is a Continuation of 09/221,634, filed December 23, 1998.

Others on additional sheet(s) attached? _____

Yes

X No

4. Nature of Conveyance:

☒ ASSIGNMENT

Merger

Change of Name:

Verified Translation

Security Agreement

Other: _____

Execution Date:

RANDY L. YACH: 12.18.98

IGOR WOJEWODA: 12.17.98

5. Name and address of party to whom correspondence concerning document should be mailed:

6.

PAUL N. KATZ
 BAKER BOTTS L.L.P. (023640)
 ONE SHELL PLAZA
 910 LOUISIANA STREET
 HOUSTON, TEXAS 77002-4995
 713.229.1343 (TELEPHONE)
 713.229.7743 (FACSIMILE)

7. Total number of applications and patents involved:

Application(s): 1

+ Patent(s):

= Total: 1

8. Total Fee (37 C.F.R. § 3.41) \$40.00

9. Authorized to be charged to Deposit Account YES

10. Deposit Account No.: 02-0383

(Duplicate copy of this sheet attached)

Charge any underpayment or credit any overpayment to above Deposit Account, order no. 068354.1087

DO NOT USE THIS SPACE

11. Statement and Signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

PAUL N. KATZ (Reg. No. 35,917)

Name of Person Signing

Paul N. Katz

Signature

APRIL 30, 2001

Date

Total number of pages including cover sheet, attachments, and document: 4 PAGES



ASSIGNMENT AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, We, **Randy L. Yach and Igor Wojewoda**, have sold, assigned and transferred and do hereby sell, assign and transfer unto **MICROCHIP TECHNOLOGY INCORPORATED**, and its successors, assigns and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in "**IMPROVED LAYOUT TECHNIQUE FOR A CAPACITOR ARRAY USING A CONTINUOUS UPPER ELECTRODE**" described, illustrated and claimed in an application for Letters Patent of the United States of America, executed by us of even date herewith, together with the entire right, title and interest in and to said application, and in and to Letters Patent which may be issued upon said application, and upon any division, extension, continuation or reissue thereof.

We also hereby sell, assign and transfer unto the said **MICROCHIP TECHNOLOGY INCORPORATED**, the entire right, title and interest in and to said invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of said inventions and said applications for Letters Patent in foreign countries, and we further authorize the said **MICROCHIP TECHNOLOGY INCORPORATED**, to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the said application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.


We hereby authorize and request the Assistant Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to the **MICROCHIP TECHNOLOGY INCORPORATED**, for the sole use and behoof of said **MICROCHIP TECHNOLOGY INCORPORATED**, its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be

granted, the same as they would have been held and enjoyed by us had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to the said **MICROCHIP TECHNOLOGY INCORPORATED**.

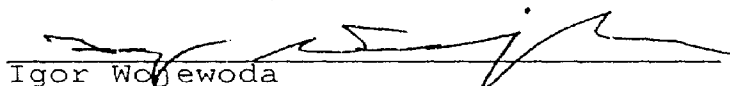
We agree that, when requested, we will, without charge to said **MICROCHIP TECHNOLOGY INCORPORATED**, but at its expense, sign all papers take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for said inventions in all countries and for vesting title thereto in said **MICROCHIP TECHNOLOGY INCORPORATED**, its successors, assigns and legal representatives or nominees.

We covenant with said **MICROCHIP TECHNOLOGY INCORPORATED**, its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

Dated: 12-18-98


Randy L. Yach

Dated: 12/17/98


Igor Wojewoda